

**PDFN3.3X3.3-8 P Channel Enhancement 沟道增强型  
MOS Field Effect Transistor 场效应管**

**■Features 特点**

Low on-resistance 低导通电阻

$R_{DS(ON)}=6\text{m}\Omega$ (Type)@ $V_{GS}=-10\text{V}$

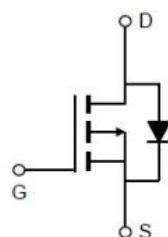
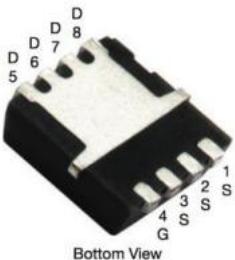
$R_{DS(ON)}=11\text{m}\Omega$ (Type)@ $V_{GS}=-4.5\text{V}$

**■Applications 应用**

Portable Equipment 便携设备

Power Management 电源管理

**■Internal Schematic Diagram 内部结构**



**■Absolute Maximum Ratings 最大额定值**

Characteristic 特性参数	Symbol 符号	Rating 额定值	Unit 单位
Drain-Source Voltage 漏极-源极电压	$BV_{DSS}$	-30	V
Gate- Source Voltage 栅极-源极电压	$V_{GS}$	$\pm 20$	V
Drain Current (continuous)漏极电流-连续	$I_D$ (at $T_A = 25^\circ\text{C}$ at $T_C = 25^\circ\text{C}$ )	-16 -50	A
Drain Current (pulsed)漏极电流-脉冲	$I_{DM}$	-70	A
Total Device Dissipation 总耗散功率	$P_{TOT}$ (at $T_A = 25^\circ\text{C}$ at $T_C = 25^\circ\text{C}$ )	3.1 30	W
Avalanche Energy(Single Pulse)雪崩能量	$E_{AS}$	49	mJ
Thermal Resistance Junction-Ambient 热阻	$R_{\theta JA}/R_{\theta JC}$	40/4.2	°C/W
Junction/Storage Temperature 结温/储存温度	$T_J, T_{stg}$	-55~150	°C

**■ Electrical Characteristics 电特性**(T<sub>A</sub>=25°C unless otherwise noted 如无特殊说明，温度为 25°C)

Characteristic 特性参数	Symbol 符号	Min 最小值	Typ 典型值	Max 最大值	Unit 单位
Drain-Source Breakdown Voltage 漏极-源极击穿电压(I <sub>D</sub> = -250uA, V <sub>GS</sub> =0V)	BV <sub>DSS</sub>	-30	—	—	V
Gate Threshold Voltage 栅极开启电压(I <sub>D</sub> = -250uA, V <sub>GS</sub> = V <sub>DS</sub> )	V <sub>GS(th)</sub>	-1	-1.5	-3	V
Zero Gate Voltage Drain Current 零栅压漏极电流(V <sub>GS</sub> =0V, V <sub>DS</sub> = -30V)	I <sub>DSS</sub>	—	—	-1	μA
Gate Body Leakage 栅极漏电流(V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V)	I <sub>GSS</sub>	—	—	±100	nA
Static Drain-Source On-State Resistance 静态漏源导通电阻(I <sub>D</sub> = -16A, V <sub>GS</sub> = -10V) (I <sub>D</sub> = -8A, V <sub>GS</sub> = -4.5V)	R <sub>DSS(ON)</sub>	—	6 11	8 15	mΩ
Diode Forward Voltage Drop 内附二极管正向压降(I <sub>SD</sub> = -1A, V <sub>GS</sub> =0V)	V <sub>SD</sub>	—	-0.7	-1	V
Input Capacitance 输入电容 (V <sub>GS</sub> =0V, V <sub>DS</sub> = -15V,f=1MHz)	C <sub>ISS</sub>	—	2300	—	pF
Common Source Output Capacitance 共源输出电容(V <sub>GS</sub> =0V, V <sub>DS</sub> = -15V,f=1MHz)	C <sub>OSS</sub>	—	400	—	pF
Reverse Transfer Capacitance 反馈电容 (V <sub>GS</sub> =0V, V <sub>DS</sub> = -15V,f=1MHz)	C <sub>RSS</sub>	—	350	—	pF
Total Gate Charge 栅极电荷密度 (V <sub>DS</sub> = -15V, I <sub>D</sub> = -16A, V <sub>GS</sub> = -10V)	Q <sub>g</sub>	—	20	—	nC
Gate Source Charge 栅源电荷密度 (V <sub>DS</sub> = -15V, I <sub>D</sub> = -16A, V <sub>GS</sub> = -10V)	Q <sub>gs</sub>	—	1	—	nC
Gate Drain Charge 栅漏电荷密度 (V <sub>DS</sub> = -15V, I <sub>D</sub> = -16A, V <sub>GS</sub> = -10V)	Q <sub>gd</sub>	—	8	—	nC
Turn-ON Delay Time 开启延迟时间 (V <sub>DS</sub> = -15V I <sub>D</sub> = -1A, R <sub>GEN</sub> =6 Ω, V <sub>GS</sub> = -10V)	t <sub>d(on)</sub>	—	12	—	ns
Turn-ON Rise Time 开启上升时间 (V <sub>DS</sub> = -15V I <sub>D</sub> = -1A, R <sub>GEN</sub> =6 Ω, V <sub>GS</sub> = -10V)	t <sub>r</sub>	—	11	—	ns
Turn-OFF Delay Time 关断延迟时间 (V <sub>DS</sub> = -15V I <sub>D</sub> = -1A, R <sub>GEN</sub> =6 Ω, V <sub>GS</sub> = -10V)	t <sub>d(off)</sub>	—	38	—	ns
Turn-OFF Fall Time 关断下降时间 (V <sub>DS</sub> = -15V I <sub>D</sub> = -1A, R <sub>GEN</sub> =6 Ω, V <sub>GS</sub> = -10)	t <sub>f</sub>	—	50	—	ns

■Typical Characteristic Curve 典型特性曲线

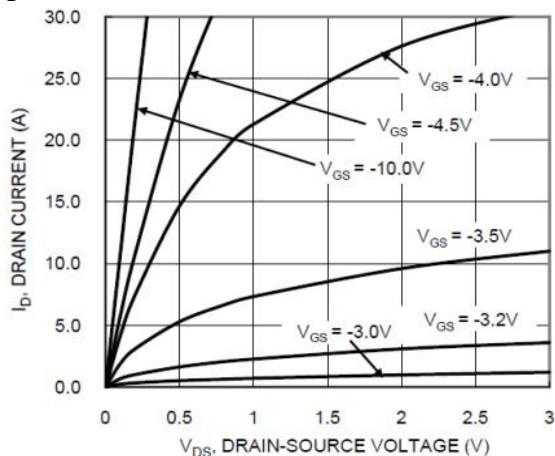


Figure 1: Output Characteristics

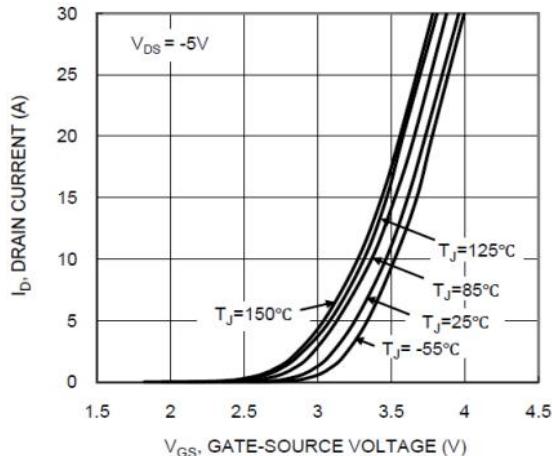


Figure 2: Transfer Characteristics

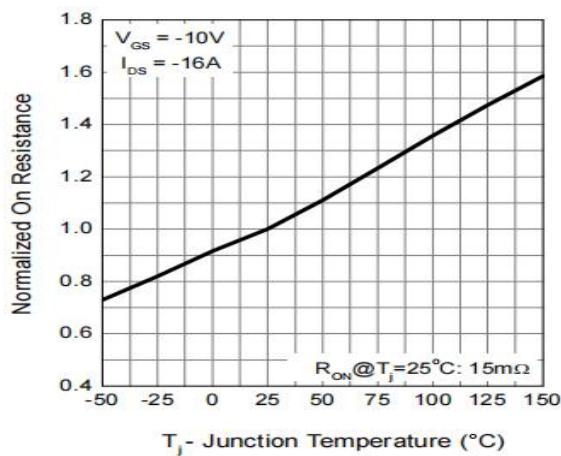


Figure 3: On-Resistance vs.  $T_J$

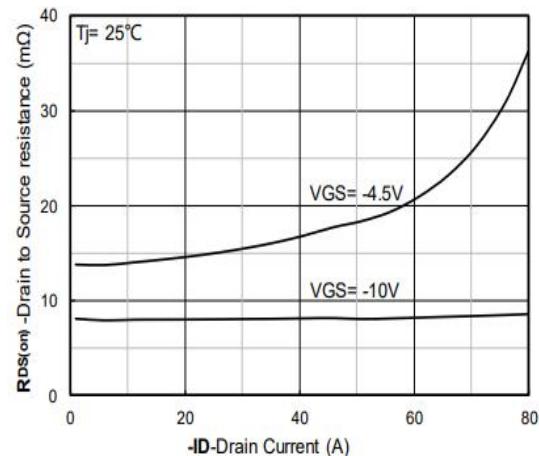


Figure 4: On-Resistance vs. Drain Current

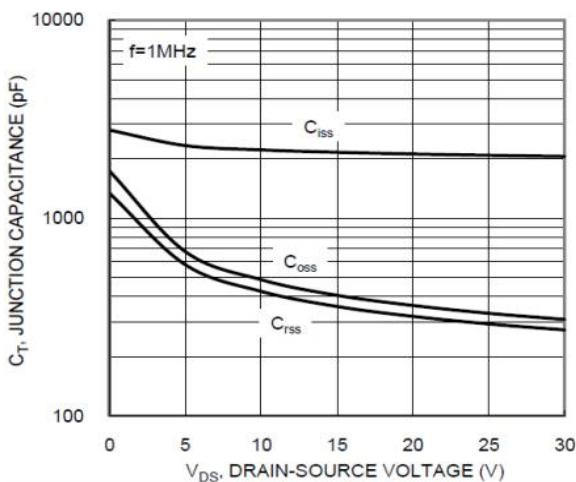


Figure 5: Capacitance Characteristics

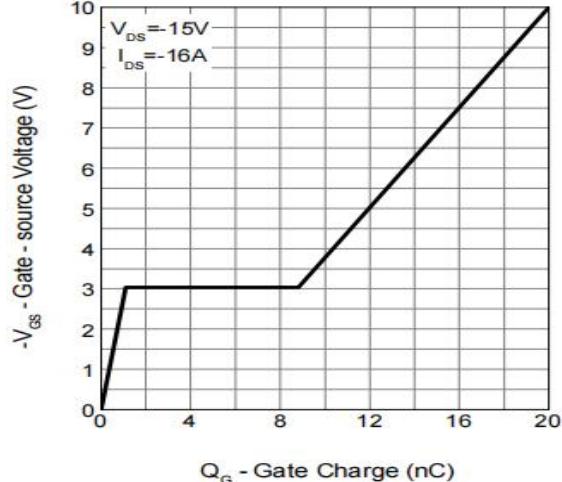


Figure 6: Gate-Charge Characteristics

■Typical Characteristic Curve 典型特性曲线

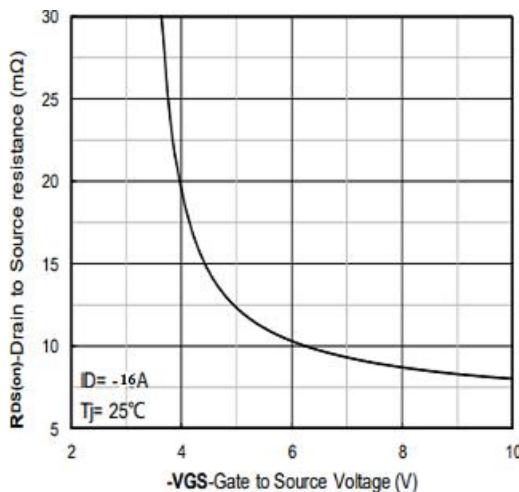


Figure 7: On-Resistance vs.  $V_{GS}$

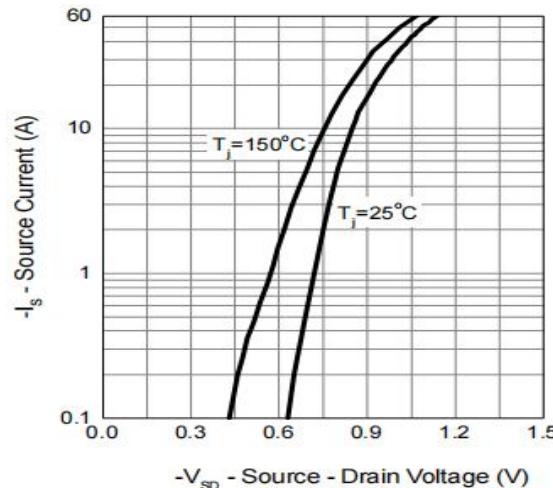


Figure 8: Diode Characteristics

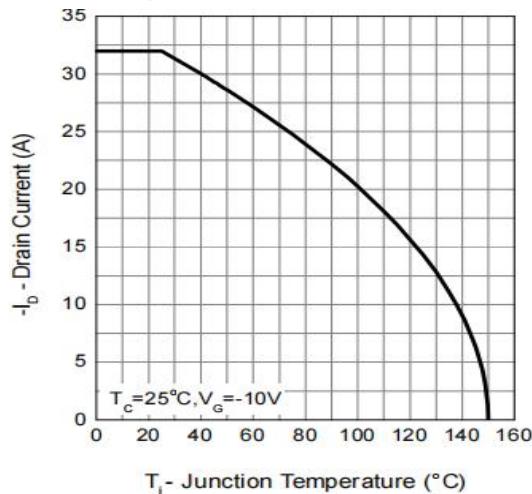


Figure 9: Drain Current Characteristics

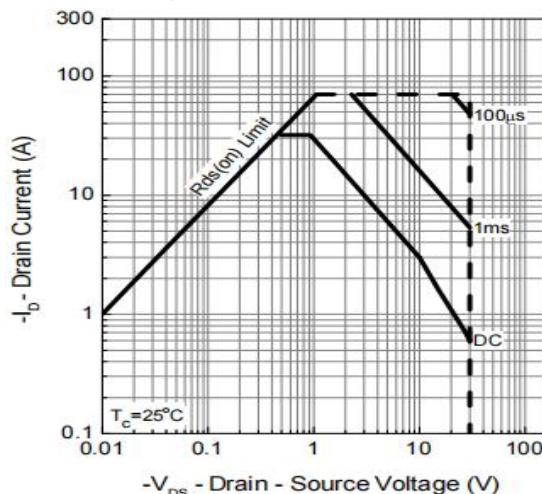


Figure 10: Safe Operating Area

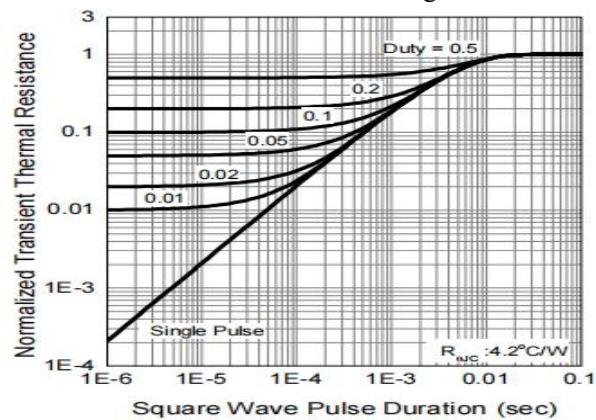
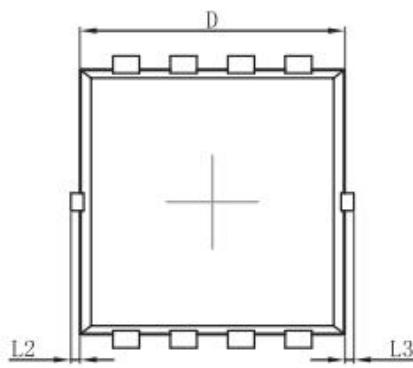
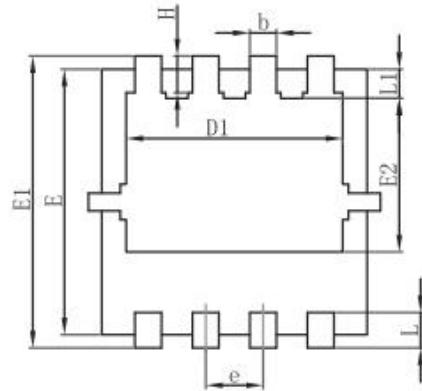


Figure 11: Transient Thermal Response Curve

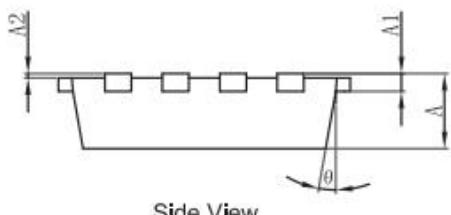
## ■ Dimension 外形封装尺寸



Top View



Bottom View



Side View

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.650	0.850	0.026	0.033
A1	0.152 REF.			0.006 REF.
A2	0~0.05			0~0.002
D	2.900	3.100	0.114	0.122
D1	2.300	2.600	0.091	0.102
E	2.900	3.100	0.114	0.122
E1	3.150	3.450	0.124	0.136
E2	1.535	1.935	0.060	0.076
b	0.200	0.400	0.008	0.016
e	0.550	0.750	0.022	0.030
L	0.300	0.500	0.012	0.020
L1	0.180	0.480	0.007	0.019
L2	0~0.100			0~0.004
L3	0~0.100			0~0.004
H	0.315	0.515	0.012	0.020
θ	9°	13°	9°	13°